

PHOTOREACTIVE RESIN COMPOSITION, METHOD FOR MAKING CIRCUIT
SUBSTRATE USING SAME, AND METHOD FOR MAKING CERAMIC
MULTILAYER SUBSTRATE USING SAME

ABSTRACT OF THE DISCLOSURE

A photoreactive resin composition contains (a) a powdered base metal, (b) an organic binder, (c) a photosensitive organic component, and (d) a polycarboxylic acid-based dispersing agent with a molecular weight of about 1,500 or less. Also disclosed is a method for making a circuit substrate or a ceramic multilayer substrate including the step of forming a conductive pattern using the photoreactive resin composition.